

PUBLIC NOTICE
#24-134

Sealed bids will be received for the FY25 supply of Chip Seal Aggregate, located at 575 East Brigham Road, St. George, Utah.

Bids must be submitted in a sealed envelope by 2:00 pm, Tuesday, July 9, 2024, to:

The City of St. George, Purchasing Department
Attn: Mary Wahl, Purchasing Manager
175 East 200 North, St. George, Utah, 84770

Each sealed envelope containing a bid must be plainly marked on the outside “#24-134 Chip Seal Aggregate.”

The bids shall be opened in an electronic meeting. Notice for the bid opening shall be emailed to everyone on the Plan Holders List prior to the bid opening.

Technical questions regarding the Bidding Documents shall be directed to Jay Sandberg, City Engineer, jay.sandberg@sgcity.org.

The BID includes the following: Supply of Chip Seal Aggregate.

All bidders who submit a bid are required to be on the Plan Holders List. Addenda will only be provided to the plan holders that are on the Plan Holders List.

To download bidding documents and to be added to the Plan Holder List, go to <https://tinyurl.com/25ChipAggregate>.

If the link does not work, email monty.thurber@sgcity.org.

City of St. George reserves the right to reject any, or all bids, or to waive any formality or technicality in any bid, in the interest of the City.

Post Notice: June 25, 2024 - July 9, 2024.